

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Sung Dae CHO
Assignee: Samsung Electronics Co., Ltd.
Title: Reel-Deployed Printed Circuit Board For Manufacturing Chip-On-Board Packages
Serial No.: Not Yet Assigned Filing Date: April 5, 2001
Examiner: Not Yet Assigned Group Art Unit: 1765
Docket No.: AB-698-1D US

21A
8/27/01
M. Hughes

Newport Beach, California
April 5, 2001

COMMISSIONER FOR PATENTS
Washington, D. C. 20231

PRELIMINARY AMENDMENT

Dear Sir:

Please cancel claims 10-20.

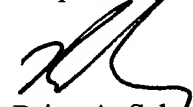
I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Commissioner for Patents, Washington, D.C. 20231, on April 5, 2001.

Attorney for Applicant(s)

April 5, 2001
Date of Signature

Express Mail No. EL661591824US

Respectfully submitted,



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